

A schematic diagram of a device 10, which is a multi-layered assembly. The device consists of several horizontal layers. The top layer is labeled 11. Below it is a layer containing four circular components labeled 24, each with a vertical line extending upwards labeled 27. This layer is also labeled 26. Below this is a layer labeled 30. The bottom layer is labeled 16. On the left side, there is a circular component labeled 12 with an arrow pointing left, and a circular component labeled 31 with an arrow pointing right. A vertical line labeled 32 connects the top layer 11 to the bottom layer 16. A vertical line labeled 17 connects the layer 30 to the bottom layer 16. On the right side, there is a vertical line labeled 22, a horizontal line labeled 21, and a vertical line labeled 18. A horizontal line labeled 19 connects the bottom layer 16 to the vertical line 18. A vertical line labeled 13 connects the top layer 11 to the bottom layer 16. A vertical line labeled 14 connects the top layer 11 to the bottom layer 16. A vertical line labeled 13 connects the top layer 11 to the bottom layer 16. A vertical line labeled 13 connects the top layer 11 to the bottom layer 16.

[illegible]

FIG. 2

FIG. 4



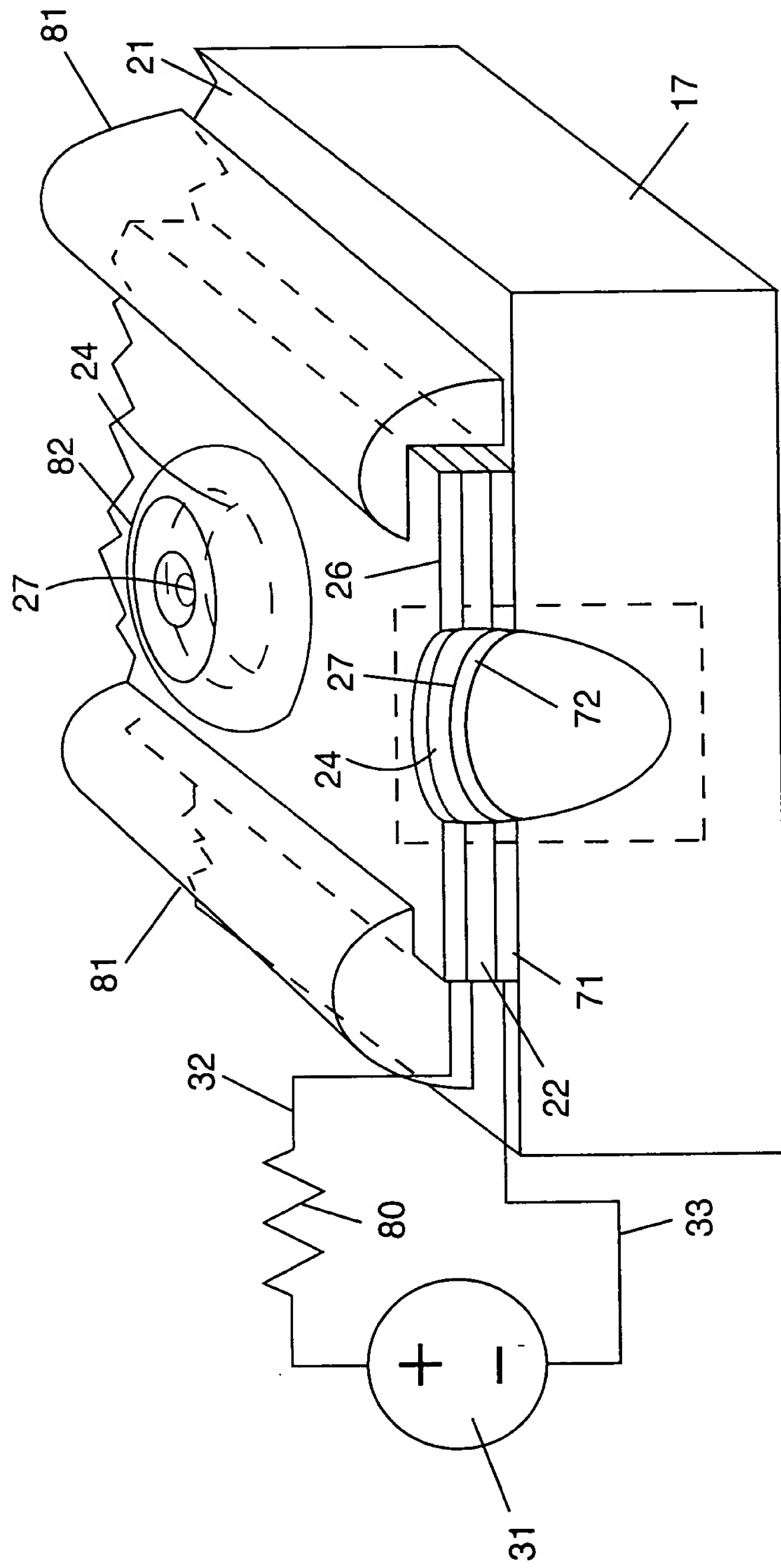


FIG. 6

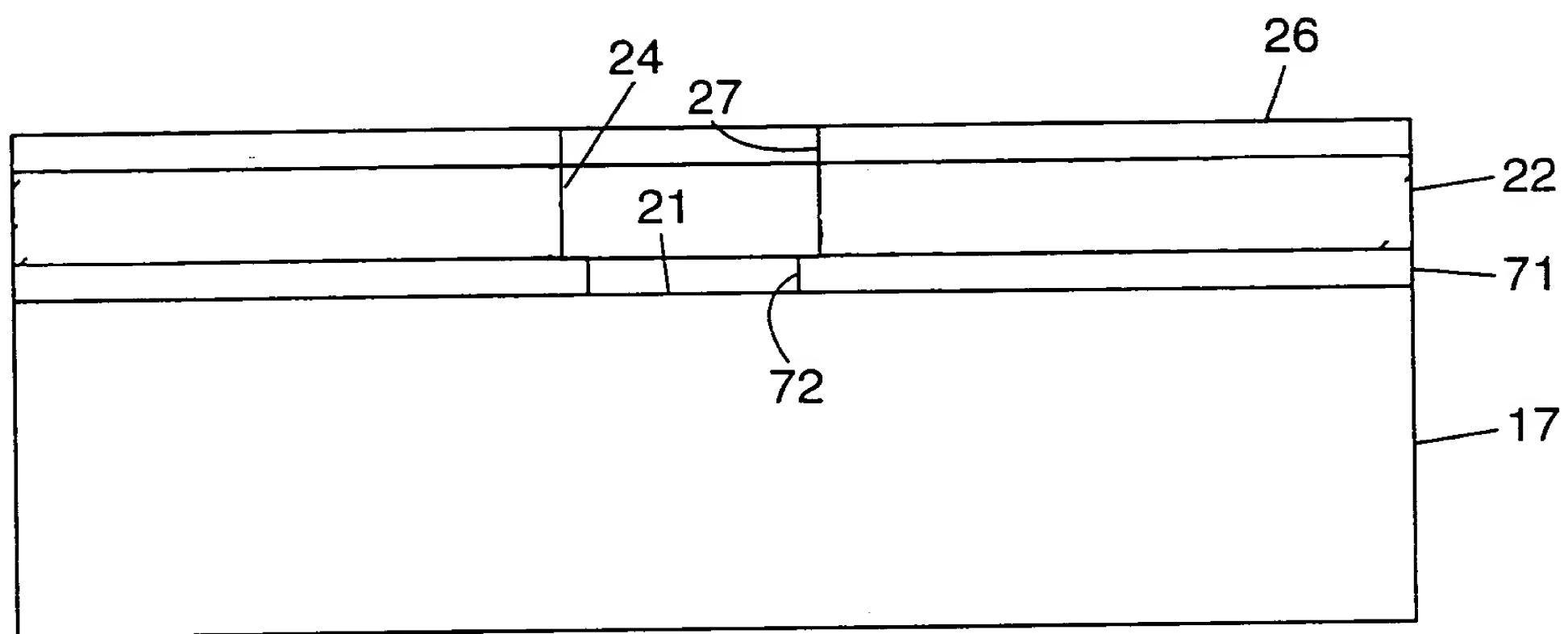


FIG. 7

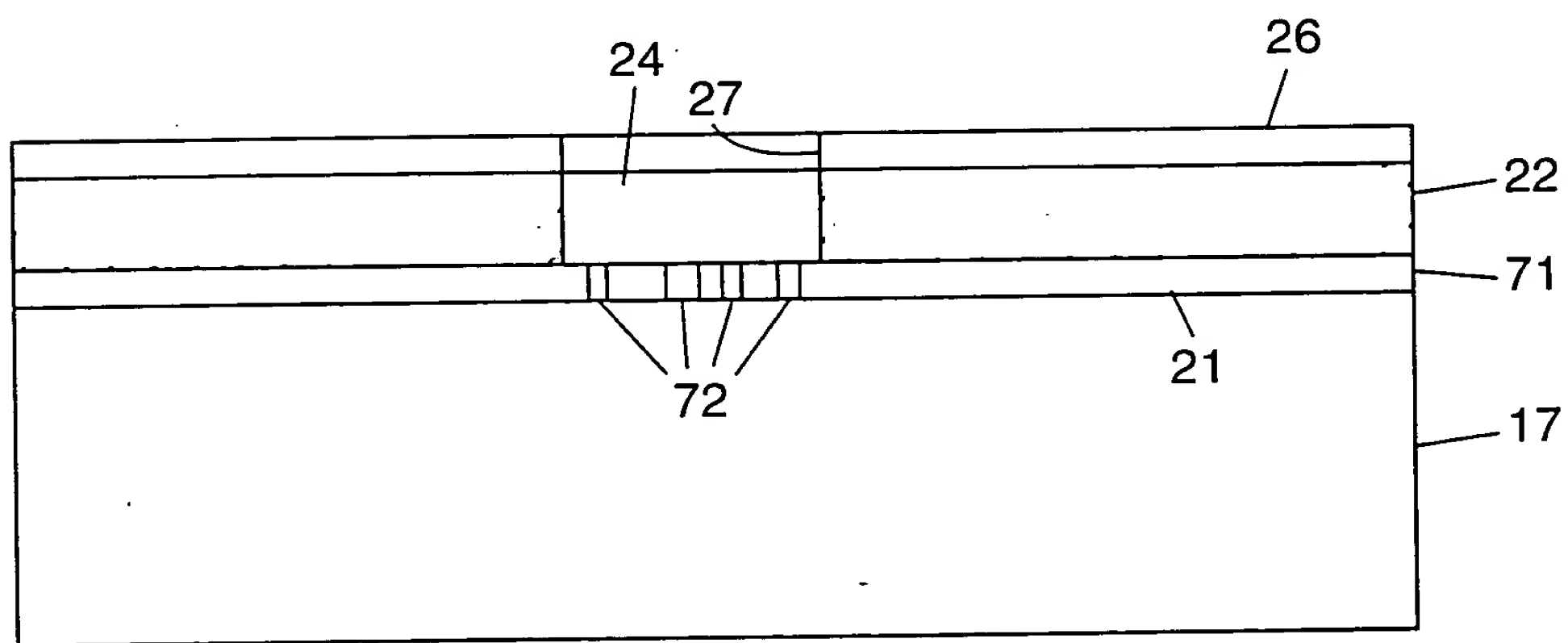


FIG. 8

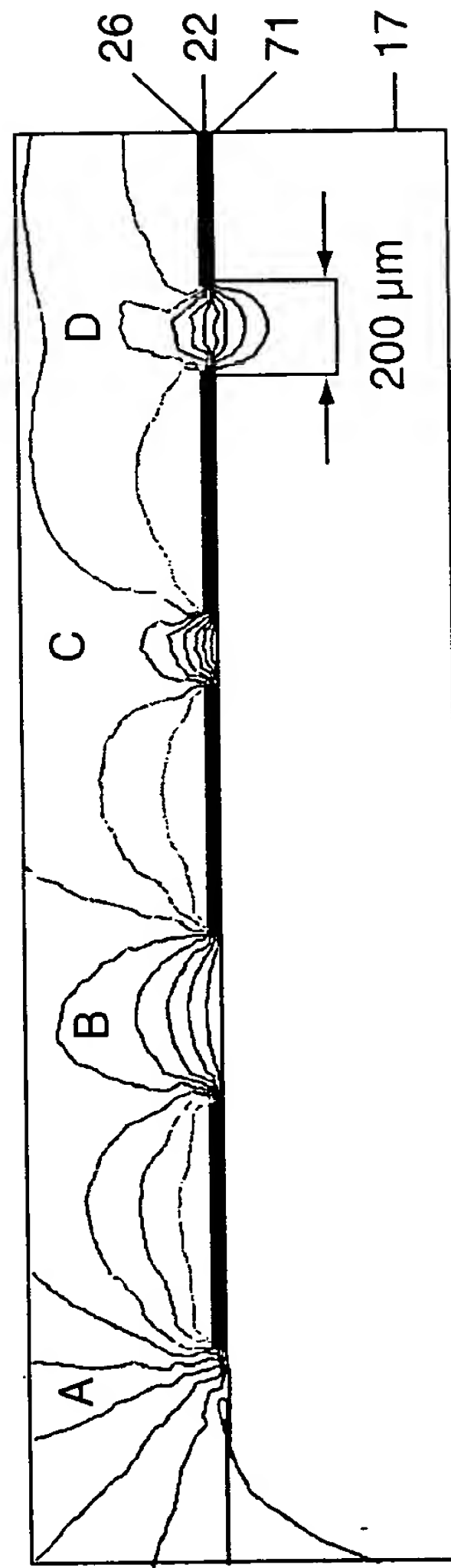


FIG. 9

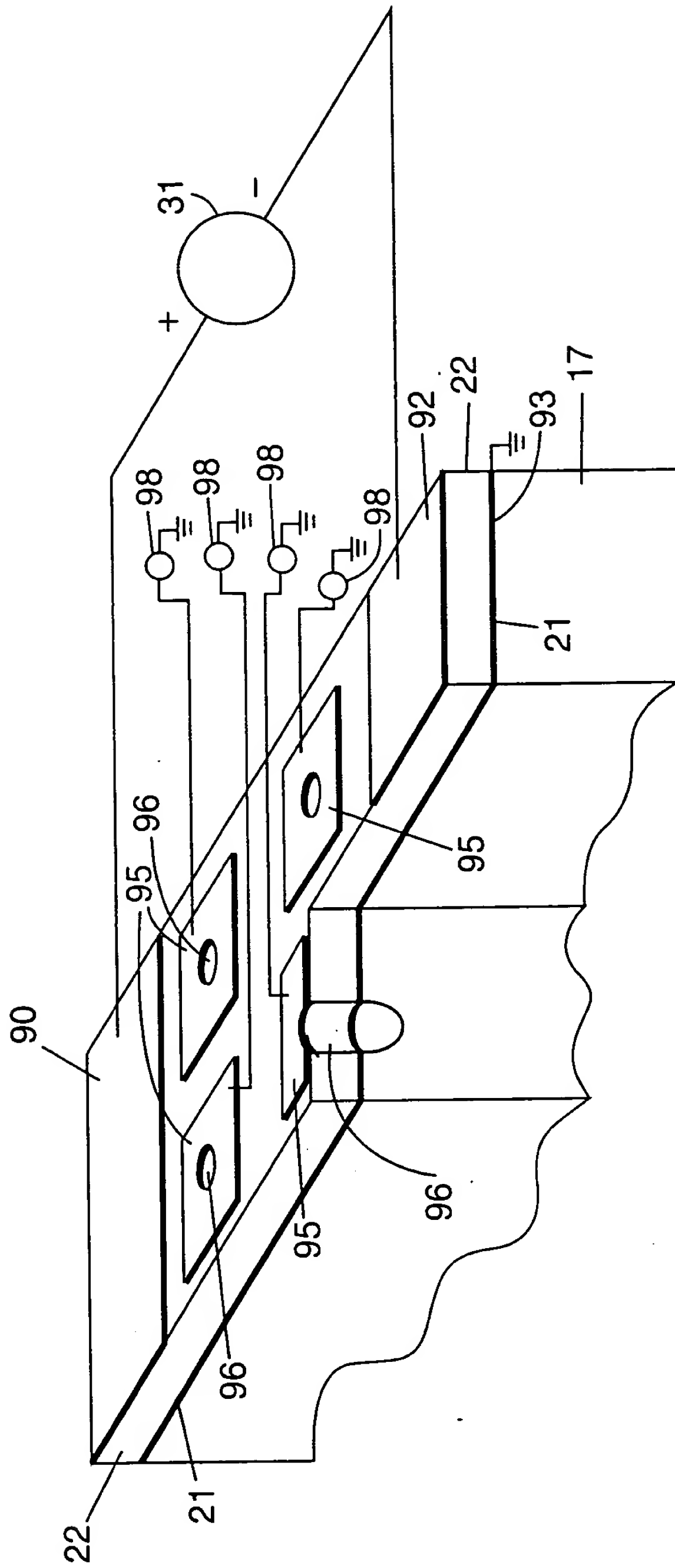


FIG. 10

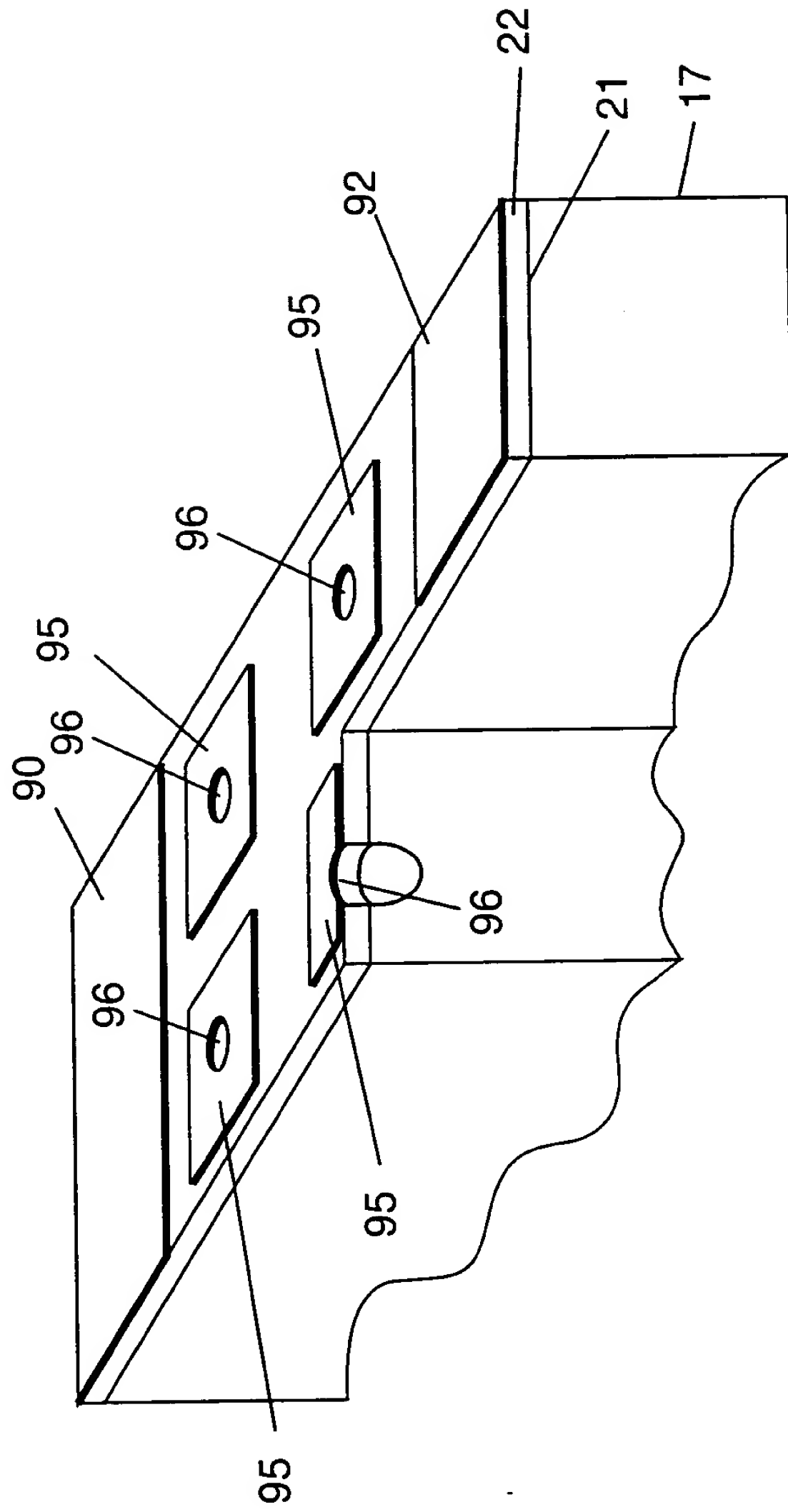


FIG. 11



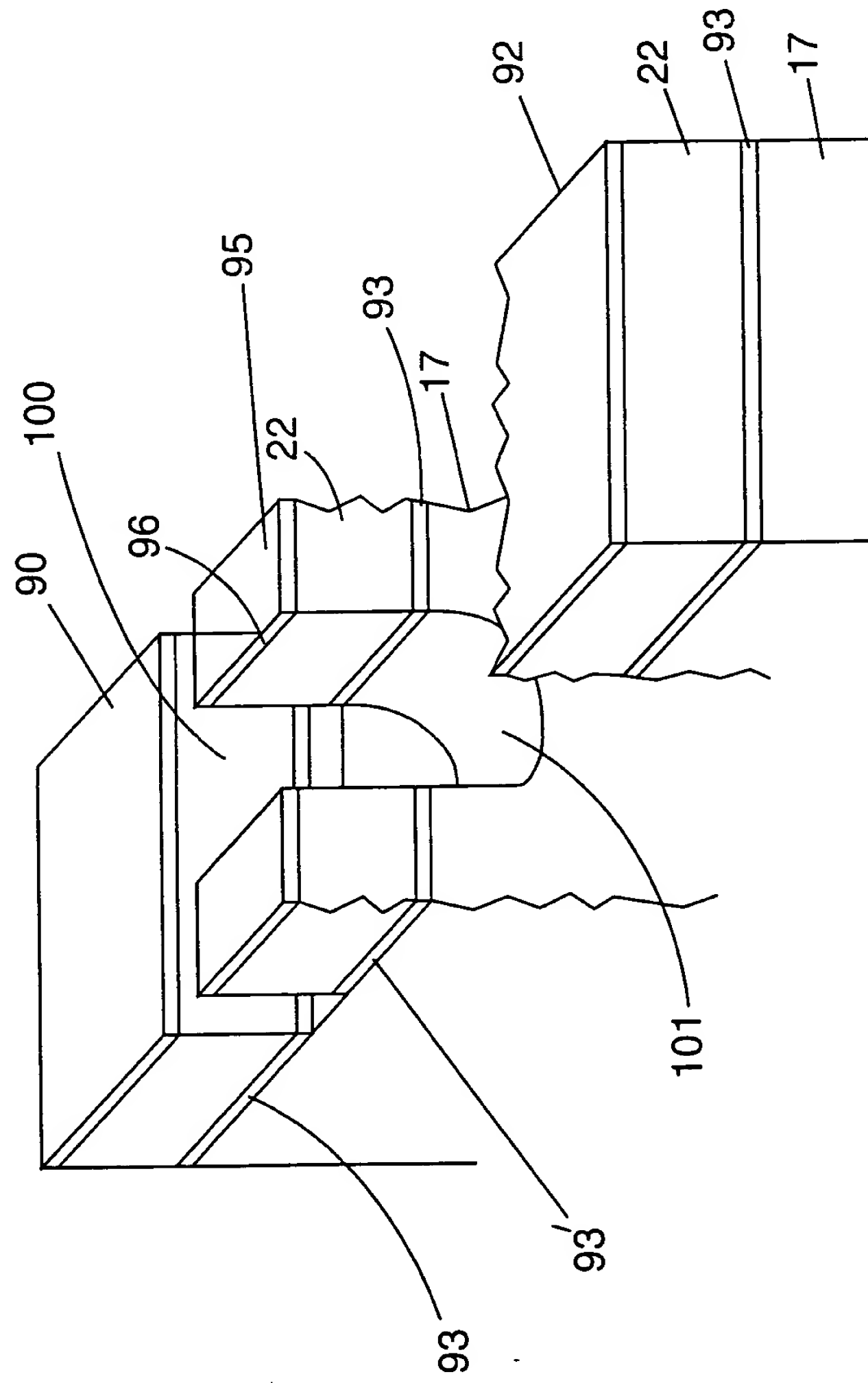


FIG. 12